



## **Features**

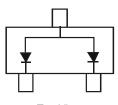
- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, (Note 5); UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)



Top View



Top View Internal Schematic

### Ordering Information (Notes 5 & 6)

Part Number	Qualification	Case	Packaging
BAW56W-7-F	Commercial	SOT323	3000/Tape & Reel
BAW56WQ-7-F	Automotive	SOT323	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.liodes.com/quality/. 5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date

Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

6. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



KJC = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019)M = Month (ex: 9 = September)

Date Code Key

Year	2005	2006	2007	2008	2009	2010		2019	2020	2021	2022	2023	2024
Code	S	Т	U	V	W	Х		G	Н		J	K	L
Month	Jan	Feb	Mar	Apr	Ma	y J	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8	9	0	Ν	D



# Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> VR	75	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	53	V
Forward Continuous Current (Note 7)	IFM	300	mA
Average Rectified Output Current (Note 7)	Io	150	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs (Note 7) @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	A

## **Thermal Characteristics**

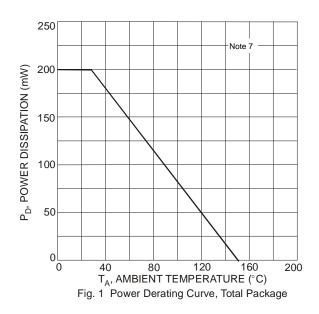
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 7)	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

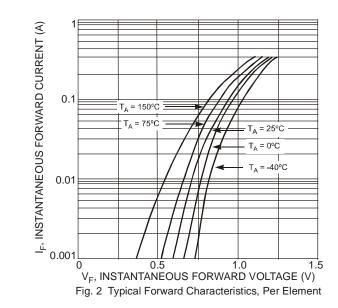
## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V <sub>(BR)R</sub>	75	—	V	I <sub>R</sub> = 2.5μΑ
Forward Voltage	VF	_	0.715 0.855 1.0 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Reverse Current (Note 8)	I <sub>R</sub>	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V, T_J = 150^{\circ}C$ $V_R = 25V, T_J = 150^{\circ}C$ $V_R = 20V$
Total Capacitance	CT	_	2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	—	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

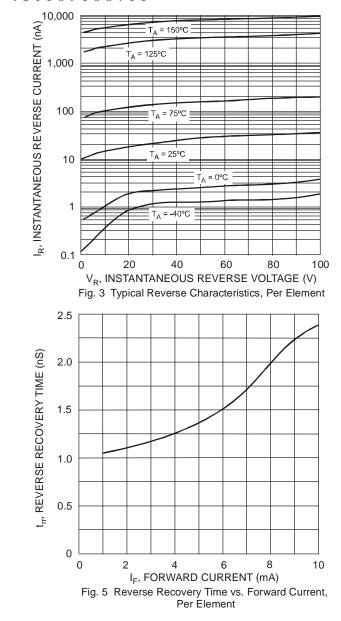
Notes:

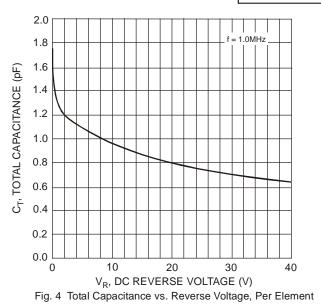
Part mounted on FR-4, 2oz 1inch squared copper pad PC board.
Short duration pulse test used to minimize self-heating effect.







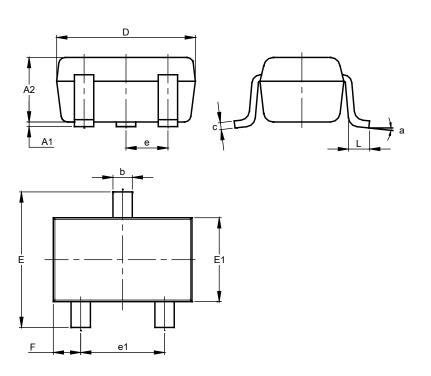






## Package Outline Dimensions

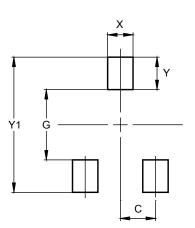
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT323							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.25	0.40	0.30				
C	0.10	0.18	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
e	0.650 BSC						
e1	1.20	1.40	1.30				
F	0.375	0.475	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All	All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensione	Value
Dimensions	(in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500

### SOT323

SOT323



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